Electrical and thermal transport in metallic single-wall carbon nanotubes on insulating substrates

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We analyze transport in metallic single-wall carbon nanotubes (SWCNTs) on insulating substrates over the bias range up to electrical breakdown in air. To account for Joule self-heating, a temperature-dependent Landauer model for electrical transport is coupled with the heat conduction equation along the nanotube. The electrical breakdown voltage of SWCNTs in air is found to scale linearly with their length, approximately as 5 V/μm; we use this to deduce a thermal conductance between SWCNT and substrate \( g \approx 0.17 \pm 0.03 \text{ W K}^{-1} \text{ m}^{-1} \) per tube length, which appears limited by the SWCNT-substrate interface rather than the thermal properties of the substrate itself. We examine the phonon scattering mechanisms that limit electron transport, and find the strong temperature dependence of the optical phonon absorption rate to have a remarkable influence on the electrical resistance of micron-length nanotubes. Further analysis reveals that unlike in typical metals, electrons are responsible for less than 15% of the total thermal conductivity of metallic nanotubes around room temperature, and this contribution decreases at high bias or higher temperatures. For interconnect applications of metallic SWCNTs, significant self-heating may be avoided if power densities are limited below 5 μW/μm, or if the SWCNT-surrounding thermal interface is optimized. © 2007 American Institute of Physics. [DOI: 10.1063/1.2717855]

I. INTRODUCTION

Single-wall carbon nanotubes (SWCNTs) are cylinders formed by a sheet of hexagonally arranged carbon atoms (graphene) wrapped into a nanometer-diameter tube.1,2 These molecular wires have attracted considerable scientific and engineering interest due to their outstanding electrical and thermal transport properties. Depending on their wrapping (chiral) angle, SWCNTs exhibit either semiconducting or metallic behavior.3 Within integrated circuits, semiconducting SWCNTs can be used for transistor device applications,4 while metallic SWCNTs have been proposed as advanced interconnects.5 Compared to typical copper interconnects, SWCNTs can carry up to two orders of magnitude higher current densities (\( \sim 10^9 \text{ A/cm}^2 \)) and are insensitive to electromigration.

Several recent studies have analyzed the promise of metallic SWCNTs as circuit elements.5–9 However, little prior work has investigated the influence of temperature on their electrical properties, an essential step in understanding their behavior within integrated circuits. Despite their high thermal conductivity, the thermal conductance of carbon nanotubes is relatively low owing to their small diameter and thermal boundary resistance with the environment.10,11 This implies that significant self-heating of SWCNTs occurs under high current conditions,12,13 a fact often overlooked in earlier studies of high bias transport in SWCNTs on insulating substrates.14–16

In this study we focus on electrical and thermal transport in metallic SWCNTs on insulating substrates, under a wide range of temperature and bias conditions. We use in-air Joule breakdown of SWCNTs to empirically extract the value of their thermal conductance to the insulating substrate. Furthermore, we describe an electrothermally self-consistent transport model suitable for circuit simulation, and compare our analysis with experimental measurements. This also represents a more general, comprehensive description of a temperature-dependent Landauer approach to onedimensional transport. We find that the low-bias electrical resistance of metallic SWCNTs with lengths relevant to interconnect applications (microns) is affected by a strong temperature dependence of the optical phonon (OP) absorption
length above 250 K. Consequently, we also thoroughly explore the temperature dependence of all relevant electron scattering mechanisms. Our results have significant implications for the viability of SWCNT-based interconnects, and the proposed model covers a wide range of voltages and temperatures of practical interest.

II. JOULE HEATING AND BREAKDOWN IN AIR

In order to study the influence of Joule self-heating on electrical transport in SWCNTs on insulating substrates, the heat loss coefficient from the tube into the substrate must be known [the \( g \) term in Fig. 1 and Eq. (1)]. This can only be estimated if both the temperature and the electrical power dissipated in the SWCNT are simultaneously available. The latter is known from the electrical \( I-V \) measurement, but the temperature profile of an individual nanotube is very difficult to obtain experimentally in a quantitative manner. However, the temperature under which SWCNTs break down by oxidation when heated and exposed to air is relatively well established from thermogravimetric analysis (TGA) experiments. Here, we exploit this mechanism to gain the additional insight into the SWCNT electrical and thermal properties, and the high temperature necessary for in-air breakdown is provided by Joule self-heating at high applied bias. We assume that the breakdown occurs when the middle of the tube (the point of highest temperature) reaches \( T_{BD} = 600 \, ^\circ\text{C} = 873 \, \text{K} \), in accord with the temperature suggested by TGA experiments.

Figure 1 shows a schematic of the SWCNT-on-substrate layout used in the experiments and the model presented here. The heat conduction equation along the length of a current-carrying SWCNT, including heat generation from Joule self-heating and heat loss to the substrate is:

\[
A \nabla \left( k \nabla T \right) + p' - g(T - T_0) = 0, \tag{1}
\]

where \( A=\pi db \) is the cross-sectional area (\( b=0.34 \, \text{nm} \) the tube wall thickness), \( k \) is the SWCNT thermal conductivity, \( p' \) is the Joule heating rate per unit length, and \( g \) is the net heat loss rate to the substrate per unit length. An analytic expression for the temperature profile \( T(x) \) along the SWCNT can first be obtained if we simplify the justifying assumptions of constant \( k \) and uniform heat generation along the tube, \( p' = \bar{p}(R - R_C)/L \), where \( R \) is the total electrical resistance of the nanotube and \( R_C \) is the combined electrical resistance of the two contacts. This is reasonable, given the relatively flat expected temperature profiles, especially in longer tubes, and yields

\[
T(x) = T_0 + \frac{p'}{g} \left[ 1 - \frac{\cosh(x/L_H)}{\cosh(L/2L_H)} \right] \tag{2}
\]

for \(-L/2 < x < L/2\), where \( T_0 \) is the temperature of the contacts at the two ends, and \( L_H = (kA/g)^{1/2} \) is the characteristic thermal heating length along the SWCNT. The prefactor \( p'/g \) is simply the peak temperature rise in the middle of the tube when \( L > L_H \), i.e., for SWCNTs several microns long (\( L_H \approx 0.2 \, \mu\text{m} \), as discussed in Sec. V below). Breakdown occurs when the maximum temperature of the tube reaches the value of the breakdown temperature (\( T_0 + p'/g = T_{BD} \)), which allows the extraction of a simple expression for the breakdown voltage of long SWCNTs,

\[
V_{BD} = gL(T_{BD} - T_0)/R_{BD}, \tag{3}
\]

where we have approximated \( p' = I_{BD} V_{BD} / L \) as the Joule power dissipated per unit length at breakdown. The breakdown current of metallic SWCNTs, longer than about 1 \( \mu\text{m} \) with good electrical contacts, is known to be generally very close to \( I_{BD} \approx 20 \, \mu\text{A} \) when laying on insulating substrates, as observed by previous researchers as well as in the course of this work. Consequently, the expression in Eq. (3) does well to reproduce the linear relationship between in-air breakdown voltage and SWCNT length observed empirically, as shown in Fig. 2. The approximation is less accurate for SWCNTs shorter than 1 \( \mu\text{m} \), when a significant portion of the Joule heat is generated and dissipated at the contacts rather than along the length of the tube itself. For simplicity, neither the thermal contact resistance nor the heat dissipation at the contacts was taken into account in the expression of Eq. (3) above. Using the finite-element model described in the later sections of this work, we have found that the breakdown voltage of SWCNTs shorter than 1 \( \mu\text{m} \) is consistent with a contact thermal resistance \( R_{C,\text{Th}} = 5 \times 10^6 \, \text{K/W} \).
however, more detailed future efforts must be made to investigate electrothermal transport in such short metallic SWCNTs. In addition, we note that when the electrical resistance at the contacts ($R_C$) is significant, the breakdown voltage in Eq. (3) is increased by approximately $I_{BD}R_C$ as

$$V_{BD} = gL(T_{BD} - T_0)/I_{BD} + I_{BD}R_C,$$

(4)

and hence the breakdown power is simply the expression above multiplied by the breakdown current.

Empirically, for metallic SWCNTs with low $R_C$ and $L > 1 \mu m$, we find that the in-air breakdown voltage ($V_{BD}$) scales linearly with the length of the tubes approximately as 5 V/μm, indicated by the dashed line in Fig. 2. This suggests that longer tubes benefit from better heat sinking into the substrate along their length, the net value of this thermal conductance being proportional to the length $L$. For example, metallic SWCNTs of 3 μm length will break down in air at about 15 V (at typical room temperature and pressure), when the electrical contact resistance is relatively low, as achievable with Pt or Pd contacts, which is exactly what was found in Ref. 14. In separate experiments we have noted that breakdown voltages in an argon ambient were nearly twice as high. Assuming an in-air breakdown temperature $T_{BD} = 600^\circ C = 873 K$ as previously mentioned, we extract a net thermal conductance to substrate $g = 0.17 W K^{-1} m^{-1}$ per tube length by fitting Eq. (3) to the empirical data in Fig. 2. This is the value used in all calculations for the remainder of this work, unless stated otherwise. Given the maximum reported range of breakdown temperatures for SWCNTs exposed to air (500 °C < $T_{BD} < 700 °C$), the thermal conductance to substrate is expected to fall in the 0.14 W K$^{-1}$ m$^{-1}$ < $g$ < 0.20 W K$^{-1}$ m$^{-1}$ range. For the approximate contact area between nanotube and substrate ($A_C = Ld$), this is equivalent to a thermal resistance per unit area ($\rho = d/g$) between 1 - 2 × 10$^{-8}$ m$^2$ K W$^{-1}$ for the span of thermal conductances ($g$ above) and SWCNT diameters ($d \sim 2 - 3$ nm) relevant here. In units of thermal conductance per unit area this corresponds to $0.5-1 \times 10^8$ W K$^{-1}$ m$^{-2}$, which falls well within the range of interface thermal conductances measured between various solids, suggesting it is the very narrow heat flow constriction at the nanotube-substrate interface which dominates heat sinking from the SWCNT, rather than the material of the substrate itself.

At this point, it is instructive to compare these numbers with the estimated thermal spreading conductance from a heated narrow cylinder resting on a thermally insulating planar slab, as schematically drawn in Fig. 1. One must be careful with the choice of thermal resistance model used to estimate this heat loss. For instance, the problem at hand (very narrow cylinder of diameter $d \ll t_{ox}$) is quite different from the heated rectangular nanowire described by Durkan et al. (rectangular nanowire of width $w \gg t_{ox}$), which is not applicable here. The heat loss in the latter case is essentially one dimensional, whereas heat spreading from the very narrow circular SWCNT is two dimensional [see Fig. 1(b)]. Following a standard reference for this type of geometry, the conductance per unit nanotube length owed to the insulator (here, silicon dioxide) alone can be estimated as

$$g_{\text{ox}} = \frac{nk_{\text{ox}}}{\ln(8t_{\text{ox}}/\pi d)},$$

(5)

where $k_{\text{ox}}$ and $t_{\text{ox}}$ are the thermal conductivity and thickness of the insulator, respectively. This yields estimates of $g_{\text{ox}} = 1.7$ and 1.0 W K$^{-1}$ m$^{-1}$ for $t_{\text{ox}} = 10$ and 67 nm in the work of Javey et al., and $g_{\text{ox}} = 0.8 W K^{-1} m^{-1}$ for the thicker $t_{\text{ox}} = 200$ nm in the work of Park et al., assuming $k_{\text{ox}} = 1.4 W m^{-1} K^{-1}$ (for thermally grown silicon dioxide) and a typical SWCNT diameter $d \approx 2$ nm. Hence, the total value of the nanotube-substrate conductance $g = 0.17 W K^{-1} m^{-1}$ inferred above from our burning temperature arguments is 5–10 times lower than the conductance owed to these insulating substrates alone. This also strongly indicates that the atomically narrow heat flow constriction at the nanotube-substrate interface is the factor that limits the heat sinking from the SWCNT, rather than the material or thickness of the insulating substrate itself. The latter accounts for only 10%–20% of the total thermal resistance from the SWCNT along its length, while any additional spreading thermal resistance introduced by the remaining thickness of the typical silicon wafer is almost two orders of magnitude lower, and therefore negligible.

The recent results of Maune et al. (which we became aware of during the preparation of this manuscript) also support the conclusions we draw above. They infer a thermal conductance per unit length about 0.26 W K$^{-1}$ m$^{-1}$ between metallic SWCNTs and a sapphire substrate, the slightly larger extracted value (compared to ours) possibly influenced by higher electrical resistance of their Au/Cr contacts [see Eq. (4)]. Nevertheless, this value is also very much in the range of typical solid-solid interface thermal conductance, and inconsistent with the much higher thermal conductivity of the sapphire substrate versus the silicon dioxide substrates considered in this work. Once again, the SWCNT-substrate interface, rather than the thermal properties of the specific substrate, appears to dominate heat dissipation from the nanotube.

III. ELECTRICAL TRANSPORT

In order to understand the electrical behavior of the metallic SWCNT over a wide range of temperatures and biases, we develop a straightforward, yet fully coupled electrothermal transport model. Figure 1 shows the SWCNT layout considered in this work and Fig. 3 illustrates the I-V characteristics of a typical 3 μm long metallic tube, up to breakdown by oxidation in air. The temperature dependence of the nanotube resistance is obtained through the temperature dependence of the electron scattering mean free paths (MFPs) with acoustic (AC) and OP phonons. The temperature profile $T(x)$ along the SWCNT is computed consistently with the power dissipated by Joule heating from Eq. (1) above. The total electrical resistance is written similarly to the Landauer-Buttiker approach, but summing over the series contribution of individual SWCNT segments of length $dx$, each at a temperature $T(x)$ as
linearly proportional with temperature. Consequently, we simulate the peak SWCNT temperature (in the middle of the tube) reaches \( T_{\text{peak}} = 873 \, \text{K} \), which occurs at \( I_{\text{BD}} = 17.2 \, \mu \text{A} \) and \( V_{\text{BD}} = 15.2 \, \text{V} \) here. The inset shows the computed temperature profile along the SWCNT at 3, 6, 9, 12, and 15 V bias from bottom to top.

\[
R(V, T) = R_C + \frac{\hbar}{4q^2} \left( 1 + \int_{-1/2}^{1/2} dx \frac{1}{\lambda_{\text{eff}}[V, T(x)]} \right),
\]

where \( R_C \) is the combined electrical resistance of the two contacts, not including the quantum contact resistance \( \hbar/4q^2 \) (arising from the mismatch of conduction channels in the SWCNT and the macroscopic electrodes) which is accounted for in the second term. The factor of 4 accounts for the four parallel one-dimensional (1D) conduction channels of a SWCNT, owed to spin degeneracy and the band degeneracy of graphene.\textsuperscript{12} The integrand with its prefactor is interpreted as the resistance of a nanotube portion of length \( dx \), i.e., \( dR = (\hbar/4q^2) dx/\lambda_{\text{eff}} \), such that the Joule heating rate per unit length in Eq. (1) is given by

\[
p' = p \frac{dR}{dx} = \frac{\hbar}{4q^2} \lambda_{\text{eff}},
\]

which is position, field, and temperature dependent through \( \lambda_{\text{eff}} \). This total, effective electron MFP is obtained from Matthiessen’s approximation\textsuperscript{14} as

\[
\lambda_{\text{eff}} = (\lambda_{\text{AC}}^{-1} + \lambda_{\text{OP,ems}}^{-1} + \lambda_{\text{OP,abs}}^{-1})^{-1},
\]

which includes elastic electron scattering with AC phonons, and inelastic electron scattering by OP emission and absorption. We note that the latter has been neglected in much previous work due to the large OP energy in SWCNTs \( (\hbar \omega_{\text{OP}} = 0.16-0.20 \, \text{eV}) \) and their low occupation near room temperature.\textsuperscript{14,16} The electron-phonon scattering MFPS in metallic SWCNTs can be expressed as \( \lambda = \nu_F \tau \), where \( \nu_F = 8 \times 10^5 \, \text{m/s} \) is the electron Fermi velocity\textsuperscript{1} and \( \tau \) is the respective electron-phonon scattering time. Around room temperature and above the AC phonon modes are thermally occupied \( (k_B T \gg \hbar \omega_{\text{AC}}) \), and their scattering rate \( (1/\tau_{\text{AC}}) \) is linearly proportional with temperature.\textsuperscript{15} Consequently, we can express the (elastic) AC scattering MFP at various temperatures as a function of the MFP at room temperature,

\[
\lambda_{\text{AC}} = \lambda_{\text{AC,300}} \left( \frac{300}{T} \right),
\]

where \( \lambda_{\text{AC,300}} \approx 1600 \, \text{nm} \) is the AC scattering length at 300 K. Owing to their high energy, the OP phonon occupation and (inelastic) scattering rates must be considered more carefully. The electron scattering rate with OP phonons can be expressed through Fermi’s golden rule\textsuperscript{35} as proportional to

\[
\frac{1}{\tau_{\text{OP}}} \propto \left( N_{\text{OP}} + \frac{1}{2} \pm \frac{1}{2} \right) D(E \pm \hbar \omega_{\text{OP}}),
\]

where \( N_{\text{OP}} = 1/[\exp(\hbar \omega_{\text{OP}}/k_B T) - 1] \) is the optical phonon occupation and \( D(E) \) is the density of states for the final electron state after scattering. The upper and lower signs correspond to OP absorption and emission, respectively. Due to the large energy of optical phonons in SWCNTs \( (\hbar \omega_{\text{OP}} = 0.16-0.20 \, \text{eV}) \), the optical phonon occupation has often been assumed to be \( N_{\text{OP}} = 0 \) in previous work, which implies negligible absorption. This assumption is relaxed here and \( N_{\text{OP}} \) is explicitly included. Furthermore, we note that for metallic tubes the electron density of states \( D(E) \) is a constant independent of energy.\textsuperscript{36} This is also a good approximation for gated semiconducting tubes biased strongly away from the band gap. Hence, from Eq. (10) and the preceding discussion, the OP phonon emission and absorption rates will scale with temperature simply as ratios of the phonon occupation terms. This is the key insight which simplifies our temperature-dependent model and renders this approach almost entirely analytical. We can now write the OP absorption length as:\textsuperscript{12}

\[
\lambda_{\text{OP,abs}}(T) = \lambda_{\text{OP,300}} \frac{N_{\text{OP}}(300) + 1}{N_{\text{OP}}(T)},
\]

where \( \lambda_{\text{OP,300}} \approx 15 \, \text{nm} \) is the spontaneous OP emission length at 300 K. This short (15 nm) distance is the characteristic length scale for OP phonon emission by the hot electrons whose energy exceeds the OP emission threshold, \( E > \hbar \omega_{\text{OP}} \). However, this is not the average OP emission MFP, which is much longer when considering that not all electron energies exceed the OP threshold. Most electrons have to gain sufficient energy from the electric field before overcoming this threshold, a length scale captured by the first right hand term in Eq. (13) below. We also note that OP emission can occur both after electrons gain sufficient energy from the electric field (field), and after an OP absorption event,

\[
\lambda_{\text{OP,ems}} = \left( 1/\lambda_{\text{OP,300}} + 1/\lambda_{\text{OP,abs}} \right)^{-1}.
\]

The former MFP can be written as

\[
\lambda_{\text{OP,ems}}(T) = \left( \frac{(\hbar \omega_{\text{OP}} - k_B T)}{qV/L} + \frac{N_{\text{OP}}(300) + 1}{N_{\text{OP}}(T) + 1} \lambda_{\text{OP,300}} \right),
\]

where the first term estimates the distance electrons of average energy \( k_B T \) must travel in the electric field \( F = V/L \) to overcome the OP emission threshold energy,\textsuperscript{12,15} and the second term represents the temperature dependence of the OP emission length beyond this threshold. The OP emission MFP after an absorption event is obtained from Eq. (13) by
replacing the first term with the OP absorption length of Eq. (11),

$$\lambda_{\text{OP,em}}^a(T) = \lambda_{\text{OP,abs}}(T) + \frac{N_{\text{OP}}(300) + 1}{N_{\text{OP}}(T) + 1}\lambda_{\text{OP,300}}. \quad (14)$$

This approach lets us express the temperature dependence of the relevant MFPs with respect to the acoustic and optical scattering lengths at 300 K. The relatively simple method works because the scattering lengths scale as ratios of the phonon occupation terms for metallic SWCNTs, whose density of states is nearly constant, as mentioned above. We note that in the limit of very small OP occupation (below room temperature) our $N_{\text{OP}}$ approaches zero, OP absorption can be neglected and the MFPs estimated above reduce to those of Refs. 14–16.

**IV. COUPLED ELECTROTHERMAL TRANSPORT**

The temperature profile along a current-carrying SWCNT depends on the Joule power dissipated, and hence on its resistance. In order to obtain the $I$-$V$ curves, Eqs. (1) and (6)–(16) are computed self-consistently along the length of the tube. We use a damped (overrelaxed) iterative approach, with the temperature and other quantities of the previous iteration being used as initial conditions for the next. This method aids convergence, in the sense that the temperature profile at iteration $j$ is “damped” using the temperature at the previous step as

$$T_j = \alpha T_j + (1 - \alpha T_{j-1}), \quad (15)$$

where the damping parameter is $0 < \alpha < 1$. Naturally, a choice of too small $\alpha$ can make the model too slow, while a value too close to unity may lead to convergence problems. We have found values in the range of 0.2–0.4 to be suitable here. At the beginning of an iteration, the $T_j(x)$ profile is first obtained from the solution of the heat conduction equation [Eq. (1)], but it is the damped value of $T_j(x)$ that is then used to compute the MFPs and consequently the power dissipation $P'(x)$ in the next iteration. The distribution of power dissipation is again introduced as the input to the heat conduction equation, and this iterative approach continues until the temperature profiles $T_j$ and $T_{j-1}$ converge within 0.1 K of each other.

The current is simply $I = V/R$, where the electrical resistance $R$ depends on temperature and bias as described above. For completeness, the choice of thermal conductivity model for metallic SWCNTs incorporated in our numerical solution depends on their length and the absolute temperature as

$$k(L, T) = [3.7 \times 10^{-7} T + 9.7 \times 10^{-10} T^2$$

$$+ 9.3 (1 + 0.5/L) T^{-2}]^{-1}, \quad (16)$$

which has an approximately $1/T$ dependence above room temperature and a slightly steeper $1/T^2$ component at temperatures approaching the burning point. However, since the dominant heat conduction pathway is down into the substrate, the results of this study are not very sensitive to thermal quantities that influence conduction along the tube (such as $k$ or $d$). For SWCNTs longer than 1 $\mu$m resting on insulating substrates, we find that the thermal conductance to the substrate ($g \approx 0.17$ W·K$^{-1}$·m$^{-1}$) per tube length, found in Sec. II) plays a more important role in determining their thermal behavior. The coupled model described here is similar to that presented with less detail in Ref. 12, but including heat loss to the substrate and excluding the OP nonequilibrium effect.

We have found that the latter is not required to reproduce the electrical characteristics of SWCNTs on insulating substrates, as compared to other recent studies that are based on solutions of the Boltzmann transport equation. This does not rule out some degree of OP nonequilibrium in nanotubes on substrates, but it does imply that OP nonequilibrium appears much weaker in SWCNTs on substrates compared to freely suspended SWCNTs. The nature and vibrational modes of the substrate itself are thought to play a significant role in reducing the OP nonequilibrium effect: solid substrates being most effective, followed by polyatomic gases, and finally by monatomic gases “touching” the tube. In other words, the more external vibrational modes are available in contact with the SWCNT, the shorter the OP phonon lifetimes of the SWCNT (as they find additional decay pathways), and the higher the current-carrying capability of the nanotube. In principle, a choice of substrate with vibrational modes closely related (coupled) with those of the SWCNT could be made to provide the shortest OP phonon lifetimes and the possibility of enhanced current flow at high bias.

**V. CURRENT-VOLTAGE CHARACTERISTICS**

The model is compared to $I$-$V$ data taken on a $3 \mu$m long and 2 nm diameter metallic SWCNT in Fig. 3. We note the current saturation close to 20 $\mu$A, and the subsequent breakdown of this tube when its peak temperature (in air) reaches approximately 600 °C. For the $3 \mu$m long SWCNT this occurs when the applied bias is near 15 V, consistently with our discussion in Sec. II (about 5 V/$\mu$m scaling of the breakdown voltage with length). It is apparent that the current saturation and eventual breakdown of the SWCNT are both thermally limited and activated effects, respectively. The temperature profile along the nanotube is plotted in the figure inset, at biases of 3, 6, 9, 12, and 15 V from bottom to top. Since the last bias in this list is very close to the breakdown point, the peak nanotube temperature can be seen approaching 873 K. The length scale over which the temperature profile flattens out away from the contacts is $L_H = (k/\gamma g)^{1/2}$ from Eq. (2) (the characteristic thermal healing length), which is approximately 0.2 $\mu$m. This suggests that all nanotubes longer than about 1 $\mu$m (the length range considered in this study) have relatively flat temperature profiles under Joule heating at high bias. Nevertheless, our model relies on a complete discretization of all equations previously mentioned along the length of the nanotube, and the MFPs and temperature profile are computed at each point. Regarding electrical transport at high bias, we ought to point out that more generally, depending on the nanotube diameter and applied field, additional (higher) electron conduction channels may come into play, although this is not evident for the particular SWCNT studied in Fig. 3.

We explore the sensitivity of the model to several parameters in Fig. 4, with the solid line corresponding to the same
I-V as in Fig. 3, and displayed here for reference. Increasing the room temperature spontaneous OP emission MFP \( \lambda_{OP,300} \) from 15 to 20 nm yields a higher saturation current, but too low an in-air breakdown voltage (versus experiment), since the total dissipated power must be the same to yield the same temperature. Once again, we note that \( \lambda_{OP,300} \) should not be mistaken for the average electron-OP scattering MFP, but rather it is only the length scale traveled by electrons with energies greater than the OP energy \( (E > \hbar \omega_{OP}) \) before OP emission occurs, which is why we are calling it the spontaneous OP emission MFP. Most electrons have energies below \( \hbar \omega_{OP} \), needing to travel farther to gain additional energy from the electric field to exceed this threshold and emit OPs, as shown by the first term on the right hand side of Eq. (13). In addition, all OP scattering lengths are dependent on temperature, as captured by the factors multiplying \( \lambda_{OP,300} \) in Eqs. (11), (13), and (14), with the OP absorption MFP having the strongest temperature dependence [Eq. (11) and Fig. 7].

Another parameter varied in Fig. 4 is the OP energy itself, which is known to be in the range of 0.16–0.20 eV, between the Brillouin zone-edge (K-point) and zone-center (\( \Gamma \)-point) optical phonon energies.\(^\text{13,16,39,42,43} \) We used \( \hbar \omega_{OP} = 0.17 \text{ eV} \) to match the experimental I-V characteristics in Fig. 3, but values of 0.16, 0.18, and 0.20 eV have also been commonly used in previous research. Undoubtedly, the “true” microscopic mechanism limit electron transport at high fields involves electron scattering with a range of phonons around the \( K \) and \( \Gamma \) points of the Brillouin zone, this range being broader at higher energies, when electrons find themselves farther away from the conduction band minima. In the context of the simple yet physical model presented in our approach it is reasonable to carefully select a suitable average, and to treat \( \hbar \omega_{OP} \) as a fitting parameter within the physically appropriate bounds mentioned above. It is also not unlikely that the SWCNT-substrate interaction (particular to each SWCNT chirality and substrate surface) could affect one of the dominant OP modes, thus enabling preferential electron scattering with the other.

The role of the substrate may ultimately be of most importance in determining the heat dissipation coefficient from the SWCNT, \( g = 0.17 \text{ W K}^{-1} \text{ m}^{-1} \) in Eq. (1) of our model. We have increased this to 0.3 W K\(^{-1} \) m\(^{-1} \) to obtain the dotted line in Fig. 4, a value not out of the realm of possibility assuming a better thermal quality of the SWCNT-substrate interface. This would significantly increase the saturation current of the metallic SWCNT, as well as its breakdown voltage in air, as the nanotube remains at lower temperatures for the same dissipated Joule power. While the SWCNT-substrate thermal interface (and constriction) resistance may not be completely eliminated, it could be engineered to yield heat dissipation coefficients of the order 1 W K\(^{-1} \) m\(^{-1} \) when the SWCNT is resting on a thin insulating layer, as discussed in Sec. II.

The hypothetical situation when heat dissipation from tube to substrate is essentially perfect (\( g \rightarrow \infty \)) is examined theoretically in Fig. 5, for several SWCNT lengths longer than 1 \( \mu \text{m} \). This suggests that perfectly \textit{isothermal} nanotubes (\( T = T_0 \)) could yield significantly higher currents than the approximately 20 \( \mu \text{A} \) routinely observed so far in experiments at high applied biases for this SWCNT length range.\(^\text{14–16} \) Hence, it is worthwhile to understand the effect of voltage \( (V) \), current \( (I) \), total power \( (IV) \), and power density \( (IV/L) \) on self-heating and the electrical characteristics of the nanotube. Figure 5 shows that for a \textit{given bias voltage} (consider, e.g., 3 V) longer SWCNTs show less effect of self-heating owing to lower power densities (\( p' \approx IV/L \) with lower current and longer length) and better heat sinking into the substrate along their length. For a \textit{given current level} (consider, e.g., 15 \( \mu \text{A} \)) the average temperature rise in the SWCNT is found to be essentially the same at all three lengths shown in Fig. 5 (e.g., approximately 20 K average temperature rise at 15 \( \mu \text{A} \)), although this same current is obviously reached at voltages that scale roughly as the respective nanotube lengths. This also implies that constant current is equivalent to constant power density \( (IV/L) \) for SWCNTs on insulating substrates in this length range, when self-heating is properly taken into account. In other words, isopower density lines
It is evident that self-heating of SWCNTs in the length range $1 < L < 10 \, \mu m$ is non-negligible under high bias and current conduction. This is due to the high power density ($p' = IV/L$) and the large thermal resistances involved. Further analyzing Fig. 5, we generally find that power densities greater than approximately $5 \, \mu W/\mu m$ lead to noticeable self-heating of SWCNTs in this length range, a simple rule which could be used as a design guideline. The assessment is more difficult for very short ($L<1 \, \mu m$) SWCNTs, as more power is dissipated at the contacts, which also play a stronger role in heat sinking. In the present study the primary focus is on the electrical and thermal transport within the SWCNT, as they dominate the behavior of micron-length tubes and are better understood than the electrical and thermal transport at the contacts. Future studies must address power dissipation issues in very short metallic nanotubes at high bias, providing a more detailed understanding of the electrical and thermal transport at the contacts.

**VI. MEAN FREE PATH AND ELECTRICAL RESISTANCE**

In Fig. 6 we turn to study the low-bias SWCNT electrical resistance. The experimental data (symbols) were taken on a 3 $\mu m$ long metallic SWCNT, similar to the one in Fig. 3, over a wide range of ambient temperatures. We note that in this case the ambient temperature fully dictates the transport in the SWCNT, since at low bias the tube is essentially isothermal and in thermal equilibrium with its surroundings. In Fig. 6(a) the experimental data are compared with our transport model including and excluding the OP absorption mechanism. Here we find that, although previously neglected, OP absorption plays a non-negligible role even at moderate to high temperatures ($T > 250 \, K$), and this scattering mechanism ought to be included in future studies of SWCNTs in this length range ($L > 1 \, \mu m$). This is explained by the strong temperature dependence of the OP absorption MFP [Eq. (11)], as clearly evident in Fig. 7. The expected temperature dependence of the low-bias resistance for various SWCNT lengths is plotted in Fig. 6(b), assuming otherwise perfect electrical and thermal electrode contacts ($R_C = 0$). Longer tubes have an earlier onset of OP phonon absorption, as is expected given the long OP absorption MFP at low bias (Fig. 7). The temperature coefficient of resistance (TCR) of metallic SWCNTs around room temperature is $\approx 0.0026 \, K^{-1}$, which is very near to that of $40 \, nm$ diameter copper vias.\textsuperscript{44} We note that the low-bias resistance of the longer tubes is expected to have the strongest temperature dependence, as the OP absorption length plays a less negligible role.

The temperature dependence of the various MFPs included in our model is shown in Fig. 7, as predicted by Eqs. (8)–(14). Figure 7(a) displays the MFPs in the low-bias regime ($60 \, mV$ across a $3 \, \mu m$ tube, or $200 \, V/cm$ field), while Fig. 7(b) samples the high-bias regime (6 $V$ across a $3 \, \mu m$ tube, or 20 $kV/cm$ field). Note the different temperature range covered by the two plots, chosen to provide more information. The OP absorption length is about $10 \, \mu m$ at room temperature and has the strongest temperature dependence (decrease) of all MFPs, which explains its non-negligible role especially at higher temperatures. Acoustic phonon scattering dominates transport at low bias as might be expected, with a $1/T$ dependence of the MFP, i.e., a linear dependence of the resistance on temperature, as in Fig. 6(a). However, at temperatures beyond approximately $250 \, K$ the strong decline in the OP absorption MFP implies a steeper decrease to the overall MFP [black solid line in Fig. 7(a)], explaining the faster upturn in the temperature dependence of the low-bias resistance, as in Fig. 6(a). The OP absorption and AC scattering MFPs are only dependent on temperature, not on the electric field, hence their trace in Fig. 7(b) is simply a continuation of that in Fig. 7(a). The OP emission MFP, however, is significantly shorter at high bias, becoming the dominant scattering mechanism. We note once again that the total OP emission MFP [Eq. (12)] varies in the range of $50–100 \, nm$ over the high temperature regime up to the nanotube burning point, and that the parameter $\lambda_{OP,300} = 15 \, nm$ constitutes only part of this MFP contribution, the mean distance necessary to emit an OP phonon once an electron reaches the $h\omega_{OP}$ energy (also highlighted in Ref. 15). Moreover, the OP emission MFP is strongly field dependent.
The temperature rise, especially for longer tubes, which essentially corresponds to the burning point in the nanometers at high temperature and high bias. The OP absorption mechanism becomes the limiting scattering mechanism, on the order of tens of nanometers at high temperature and high bias. The OP absorption mechanism continues its strong decrease with temperature, reaching $\lambda_{\text{OP,abs}} = 150$ nm near the burning point.

FIG. 7. (Color online) (a) Estimate of the various electron mean free paths (MFPs) at low bias as a function of temperature ($F=200 \text{ V/cm}$, or 60 mV across 3 $\mu$m tube). The total MFP [$\lambda_{\text{e}}$ in Eq. (8)] is also plotted (solid line). Acoustic phonon (AC) scattering dominates at low bias, but optical phonon (OP) scattering with MFPs ~10 $\mu$m at 300 K must be included as the temperature rises, especially for longer tubes (also see Fig. 6). The strong decrease of the OP scattering length is owed in particular to the exponential curve of Fig. 3. At the same high temperature the OP absorption and AC scattering MFPs are estimated to be 138 and 565 nm, respectively. In practice, of course, the specific combination of field and temperature (at every point along the nanotube) is determined by a self-consistent solution of Eqs. (1) and (6)–(16), as described in the earlier parts of this paper.

VII. ELECTRICAL AND THERMAL CONTACT RESISTANCE

The electrical contact resistance of our SWCNTs is of the order 10–100 k$\Omega$ with the Pt electrodes and is included in our model through the adjustable parameter $R_C$, as in Eq. (6). Note that in our model $R_C$ represents the combined contribution of both contacts. This mainly affects the slope of the nanotube $I$-$V$ curve at low bias, where it appears in series with the quantum contact resistance ($h/4q^2 = 6.5$ k$\Omega$) and with the intrinsic phonon-limited resistance of the SWCNT (Fig. 6 and Sec. VI). In addition, $R_C$ is not expected to be strongly temperature dependent, as the contacts remain essentially iso-thermal with the large electrodes.

The thermal contact resistance $R_{C,T_N}$ at the SWCNT-electrode junction is of the order $5 \times 10^5$ K$\Omega$ W$^{-1}$, and is included in our model by introducing Neumann boundary conditions in the heat conduction equation from Eq. (1),

$$k_A A \frac{dT_L}{dx} = \frac{T_L - T_0}{R_{C,T_N}}$$

(17)

where the subscript “$L$” denotes the point along the SWCNT nearest the left electrode contact, and $T_0$ is the ambient temperature of the electrode (e.g., 300 K). The boundary condition at the right electrode (subscript “$R$”) can be similarly written. This creates a (relatively small) temperature “slip” at the SWCNT-electrode junction, proportional to the contact thermal resistance and to the local heat flux. This slip is apparent in the inset of Fig. 3, where the high-bias temperature just inside the SWCNT edges ($T_L$ at $x=-1.5 \mu$m and $T_R$ at $x=1.5 \mu$m) becomes higher than $T_0=300$ K, following Eq. (17). The numerical value of the contact thermal resistance, as mentioned above, is consistent with the area of the thermal contact and with the typical solid-solid thermal resistance per unit area ($\rho \sim 10^{-8}$ m$^2$ K W$^{-1}$, also see Sec. II).

Furthermore, we use the Wiedemann-Franz law to estimate the relative contribution of electrons and phonons to heat conduction along the nanotube and at the contacts. In its classical form this states that the part of the thermal conductivity owed to electrons is proportional to the electrical conductivity $\sigma$, the absolute temperature, and the Lorenz constant $L_0=2.45 \times 10^{-8}$ W $\Omega$ K$^{-2}$ as

$$k_e = L_0 T \sigma = L_0 T \frac{L}{R A},$$

(18)

which can also be expressed with respect to the length $L$, cross-sectional area $A$, and the electrical resistance $R$. Figure 8 compares the thermal conductivity of Eq. (16) (dashed line) with the thermal conductivity due to electrons alone (solid lines), estimated from Eq. (18) and our previous analysis of the electrical resistance at low- and high-bias conditions (Figs. 6 and 7). We note that the dashed line model of Eq. (16) is based on a high-bias extraction method, which inherently minimizes the electronic contribution to the thermal conductivity. Hence, the dashed trend is essentially equivalent to the phonon thermal conductivity, this being sufficient to analyze self-heating at high bias in SWCNTs. The electronic contribution to heat conduction is more significant at low bias, where the SWCNT electrical resistance is much lower, but self-heating itself is negligible at low bias. From Fig. 8, we estimate that the electron contribution to the SWCNT thermal conductivity is at most 440 W m$^{-1}$ K$^{-1}$ at low bias (less than 15% of the phonon thermal conductivity) and at most 60 W m$^{-1}$ K$^{-1}$ at high bias (less than 5% of the phonon thermal conductivity at high
temperature, and even smaller over the rest of the temperature range. We ought to note, that strictly speaking, the Wiedemann-Franz law is best applied when transport is dominated by elastic scattering, otherwise only providing an upper limit for the electronic thermal conductivity.

To obtain additional figures of merit, Fig. 9 summarizes the resistance components of a 2 μm long metallic SWCNT with 2 μm long contacts. From Eq. (16) we can also write down a relationship for the thermal resistance owed to electrons derived from the electrical resistance as \( R_T = R/(L_0 T) \). Once again, thermal conduction owed to electrons both along the nanotube and at the contacts appears negligible around room temperature and above, also in accord with Ref. 48. This is the case even for metallic nanotubes, a somewhat unusual result when remembering that electrons are the carriers responsible for heat transport in all typical metals. 45 For SWCNTs this can be understood owing to their extremely high phonon thermal conductivity, greater than 3000 W m\(^{-1}\) K\(^{-1}\) at room temperature. 11 The electronic contribution to the thermal conductivity of metallic SWCNTs may become more significant at temperatures below 50 K, as the phonons are quenched out, 48 but this temperature range is outside the scope of the current study.

**FIG. 8.** (Color online) Comparison of thermal conductivity owed to phonons [Eq. (16) and Ref. 11] with that due to electrons estimated from the Wiedemann-Franz law. The low- and high-bias electron thermal conductivities correspond to 60 mV and 6 V across a 3 μm long tube, respectively, same as the scenarios in Figs. 7(a) and 7(b).

**FIG. 9.** (Color online) Order of magnitude estimates for the resistance parameters of a metallic SWCNT with \( L \sim 2 \mu m \) and \( d \sim 2 nm \) at room temperature. Arrows indicate estimates obtained from the Wiedemann-Franz law showing that the heat flow resistance (conductance) owed to electrons alone is significantly larger (smaller). Hence, phonons dominate heat conduction even along metallic nanotubes (and nanotube contacts) at all temperatures of practical interest. (Ref. 48).

**VIII. CONCLUSIONS**

This work represents a study of electrical and thermal transport in metallic SWCNTs, relevant for practical interconnect applications (\( L > 1 \mu m \)), over a wide range of applied biases (up to electrical breakdown in air) and temperatures (approximately 100–800 K). Electron scattering by optical phonon absorption was found to play a previously neglected role in the low-bias resistance of long SWCNTs, while Joule self-heating must be taken into account for transport in nanotubes at high bias. In addition, the breakdown voltage of micron-long SWCNTs exposed to air was found to scale linearly with the nanotube length, as explained by heat sinking into the substrate along the nanotube. This heat dissipation coefficient \( g = 0.17 \pm 0.03 \) W K\(^{-1}\) m\(^{-1}\) appears to be very much limited by the nanoscale constriction at the SWCNT-substrate interface, rather than the thermal conductivity of the substrate itself.

We thoroughly described an electrothermal model for transport in metallic SWCNTs, based on a temperature-dependent Landauer approach self-consistently coupled with the heat conduction equation. The method is transparent, easy to implement, and should enable other researchers to reproduce a variety of SWCNT transport data over a wide range of practical voltages and temperatures. The model has been validated against experimental data, and is also readily usable for circuit simulators or other design studies. It appears that thermal management and design of high-current-carrying nanotubes will be of importance for future interconnect and device applications.
References


